

General Description

The Sanrise SRC65R600EC is a high voltage power MOSFET, fabricated using advanced super junction technology. The resulting device has extremely low on resistance, low gate charge and fast switching time, making it especially suitable for applications which require superior power density and outstanding efficiency.

The SRC65R600EC break down voltage is 650V and it has a high rugged avalanche characteristics. The SRC65R600EC is available in TO-252, TO-263-2, PDFN5*6, TO-262, TO-220F and TO-251 packages.

Features

- Ultra Low $R_{DS(ON)} = 600m\Omega @ V_{GS} = 10V$.
- Ultra Low Gate Charge, $Q_g = 18.4nC$ typ.
- Fast switching capability
- Robust design with better EAS performance
- EMI Improved Design (*SnowMOS™ Gen.2*)
- Non-automotive Qualified

Application

- TV Power
- High Performance Charger / Adapter
- LED Lighting Power

Ordering Information

| | | |
|--------------|----------------------------|-----------------|
| | SRC65R600EC□□-□ | |
| Circuit Type | | E: Lead Free |
| Package | | G: Green |
| | | Blank: Tube |
| | | TR: Tape & Reel |
| | D: TO-252, D56: PDFN5*6 | |
| | TF: TO-220F, TS: TO-262 | |
| | S2: TO-263-2, D1-G: TO-251 | |

Symbol

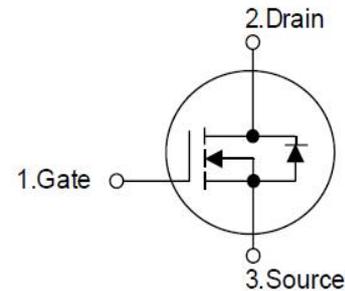


Figure 1 Symbol of SRC65R600EC

Package Type

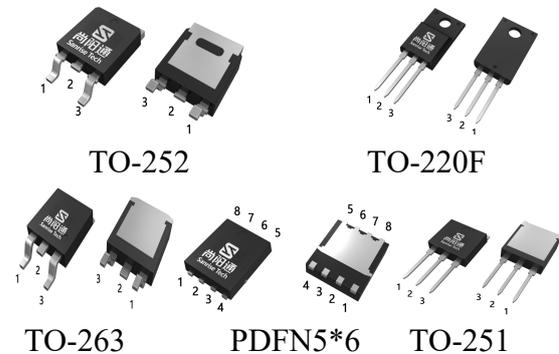


Figure 2 Package Types of SRC65R600EC

| Package | Part Number | Marking ID | Packing Type |
|----------|--------------------|-----------------|--------------|
| TO-252 | SRC65R600ECDTR-G | SRC65R600ECDG | Tape & Reel |
| TO-220F | SRC65R600ECTF-G | SRC65R600ECTFG | Tube |
| TO-262 | SRC65R600ECTS-G | SRC65R600ECTSG | Tube |
| TO-263-2 | SRC65R600ECS2TR-G | SRC65R600ECS2G | Tape & Reel |
| PDFN5*6 | SRC65R600ECD56TR-G | SRC65R600ECD56G | Tape & Reel |
| TO-251 | SRC65R600ECD1-G | SRC65R600ECD1G | Tape & Reel |

Absolute Maximum Ratings

| Parameter | Symbol | Rating | Unit |
|---|---------------|--------------------|-------------|
| Drain-Source Voltage (Note2) | V_{DSS} | 650 | V |
| Gate-Source Voltage | V_{GSS} | ±30 | V |
| Power Dissipation($T_C=25^{\circ}C, TO-252, TO-262, TO-263-2, PDFN5*6, TO-251$) | P_{tot} | 58 | W |
| Power Dissipation($T_C=25^{\circ}C, TO-220F$) | P_{tot} | 27 | W |
| Continuous Drain Current | I_D | $T_C=25^{\circ}C$ | 7.3 |
| | | $T_C=100^{\circ}C$ | 4.6 |
| | | $T_C=125^{\circ}C$ | 3.3 |
| Pulsed Drain Current (Note 4) | I_{DM} | 21.9 | A |
| Avalanche Energy, Single Pulse (Note 5) | E_{AS} | 105 | mJ |
| Avalanche Energy, Repetitive (Note 4) | E_{AR} | 0.15 | mJ |
| Avalanche Current, Repetitive (Note 4) | I_{AR} | 1.3 | A |
| Continuous Diode Forward Current | I_S | 7.3 | A |
| Diode Pulse Current | $I_{S,PULSE}$ | 24.0 | A |
| Operating Junction Temperature | T_J | 150 | $^{\circ}C$ |
| Storage Temperature | T_{STG} | -55 to 150 | $^{\circ}C$ |
| Lead Temperature (Soldering, 10 sec) | T_{LEAD} | 260 | $^{\circ}C$ |

Note:

- Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
- For voltage spike during switching.
- Repetitive Rating: Pulse width limited by maximum junction temperature
- $I_{AS} = 1.3A, V_{DD} = 60V, R_G = 25\Omega, \text{Starting } T_J = 25^{\circ}C$

Thermal characteristics

| Parameter | Symbol | Min | Typ | Max | Unit | |
|---|------------|-----|-----|----------|-----------------|------|
| Thermal resistance, Junction-to-Case | R_{thJC} | | | 4.5 | $^{\circ}C / W$ | |
| | | | | TO-220F | | 2.13 |
| | | | | TO-252 | | 2.13 |
| | | | | TO-262 | | 2.13 |
| | | | | TO-263-2 | | 2.13 |
| | | | | PDFN5*6 | | 2.13 |
| Thermal resistance, Junction-to-Ambient | R_{thJA} | | | 60 | $^{\circ}C / W$ | |
| | | | | TO-220F | | 60 |
| | | | | TO-252 | | 60 |
| | | | | TO-262 | | 60 |
| | | | | PDFN5*6 | | 60 |
| | | | | TO-263-2 | | 60 |
| TO-251 | 60 | | | | | |

Electrical Characteristics

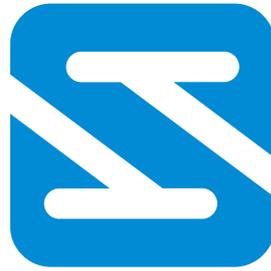
$T_J = 25^\circ\text{C}$, unless otherwise specified.

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|---|---------------|---|-----|------|------|---------|
| Statistic Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 650 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=650V, V_{GS}=0V$ | | | 1 | μA |
| Gate-Body Leakage Current | Forward | $I_{GSSF}, V_{GS}=30V, V_{DS}=0V$ | | | 100 | nA |
| | Reverse | $I_{GSSR}, V_{GS}=-30V, V_{DS}=0V$ | | | -100 | |
| Gate Threshold Voltage | $V_{GS(TH)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 2.7 | 3.6 | 4.5 | V |
| Static Drain-Source On-Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=4.0A$ | | 460 | 600 | mΩ |
| Gate Resistance | R_G | f=1MHz, Open Drain | | 8.9 | | Ω |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C_{ISS} | $V_{DS}=50V, V_{GS}=0V,$ f=1MHz | | 356 | | pF |
| Output Capacitance | C_{OSS} | | | 31.8 | | |
| Reverse Transfer Capacitance | C_{RSS} | | | 18.7 | | |
| Effective output capacitance, energy related ^{NOTE6} | $C_{O(er)}$ | $V_{GS}=0V,$ $V_{DS}=0\dots 480V$ | | 16 | | pF |
| Effective output capacitance, time related ^{NOTE7} | $C_{O(tr)}$ | | | 72 | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=400V, I_D=4.0A$ $R_G=10\Omega, V_{GS}=10V$ | | 10 | | ns |
| Rise Time | t_r | | | 12 | | |
| Turn-off Delay Time | $t_{d(off)}$ | | | 36 | | |
| Fall Time | t_f | | | 14 | | |
| Gate Charge Characteristics | | | | | | |
| Gate to Source Charge | Q_{gs} | $V_{DD}=480V, I_D=4.0A$ $V_{GS}=0$ to 10V | | 4.2 | | nC |
| Gate to Drain Charge | Q_{gd} | | | 9.1 | | |
| Gate Charge Total | Q_g | | | 18.4 | | |
| Gate Plateau Voltage | $V_{plateau}$ | | | 5.9 | | V |
| Reverse Diode Characteristics | | | | | | |
| Drain-Source Diode Forward Voltage | V_{SD} | $V_{GS}=0V, I_{SD}=4.0A$ | | 0.84 | 1.1 | V |
| Reverse Recovery Time | t_{rr} | $V_R=400V, I_F=4.0A$ $dI_F/dt=100A/\mu s$ | | 206 | | ns |
| Reverse Recovery Charge | Q_{rr} | | | 1.63 | | μC |
| Peak Reverse Recovery Current | I_{rrm} | | | 15.8 | | A |

Note:

6. $C_{O(er)}$ is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 480V

7. $C_{O(tr)}$ is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising from 0 to 480 V



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